

High Reliability Varistors





Agency Approvals

QPL

Additional Information







Description

Littelfuse High Reliability Varistors offer the latest in increased product performance, and are available for applications requiring quality and reliability assurance levels consistent with military or other standards (MIL-STD-19500, MIL-STD-202). Additionally, Littelfuse Varistors are inherently radiation hardened compared to Silicon Diode suppressors as illustrated in Figure 1.

Littelfuse High-Reliability Varistors involve four categories:

- 1 Qualified Products List (QPL) MIL-R-83530 (4 items presently available)
- 2 Littelfuse High Reliability Series TX Equivalents (29 items presently available)
- 3 Custom Types

Processed to customer-specific requirements - (SCD) or to Standard Military Flow

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1) DSSC Qualified Parts List (QPL) MIL-R-83530

This series of varistors are screened and conditioned in accordance with MIL-R-83530. Manufacturing system conforms to MIL-I-45208; MIL-Q-9858.

Table 1. MIL-R-83530/1 Ratings and Characteristics

Part Number	Nominal Varistor	Tolerance	Voltage Rating (V)		Energy	Clamping Voltage at	Capacitance	Clamping Voltage At	Nearest Commercial
M83530/	Voltage (V)	(%)	(RMS)	(DC)	Rating (J)	100A (V)	at 1MHz (pF)	Peak Current Rating (V)	Equivalent
1-2000B	200	-/+10	130	175	50	325	3800	570	V130LA20B
1-2200D	220	+10, -5	150	200	55	360	3200	650	V150LA20B
1-4300E	430	+5, -10	275	369	100	680	1800	1200	V275LA40B
1-5100E	510	+5, -10	320	420	120	810	1500	1450	V320LA40B

2) Littelfuse High Reliability Series TX Equivalents

Table 2. Available TX Model Types

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TX Model	Model Size	Device Mark	(See Section 4) Nearest Commercial Equivalent			
V8ZTX1	7mm	8TX1	V8ZA1			
V8ZTX2	10mm	8TX2	V8ZA2			
V12ZTX1	7mm	12TX1	V12ZA1			
V12ZTX2	10mm	12TX2	V12ZA2			
V22ZTX1	7mm	22TX1	V22ZA1			
V22ZTX3	14mm	22TX3	V22ZA3			
V24ZTX50	20mm	24TX50	V24ZA50			
V33ZTX1	7mm	33TX1	V33ZA1			
V33ZTX5	14mm	33TX5	V33ZA5			
V33ZTX70	20mm	33TX70	V33ZA70			
V68ZTX2	7mm	68TX2	V68ZA2			
V68ZTX10	14mm	68TX10	V68ZA10			
V82ZTX2	7mm	82TX2	V82ZA2			
V82ZTX12	14mm	82TX12	V82ZA12			

TX Model	Model Size	Device Mark	(See Section 4) Nearest Commercial Equivalent
V130LTX2	7mm	130TX2	V130LA2
V130LTX10A	14mm	130L10	V130LA10A
V130LTX20B	20mm	130TX20	V130LA20A
V150LTX2	7mm	150L2	V150LA2
V150LTX10A	14mm	150TX10	V150LA10A
V150LTX20B	20mm	150L20	V150LA20B
V250LTX4	7mm	250L4	V250LA4
V250LTX20A	14mm	250L20	V250LA20A
V250LTX40B	20mm	250L40	V250LA40B
V420LTX20A	14mm	420L20	V420LA20A
V420LTX40B	20mm	420L40	V420LA40B
V480LTX40A	14mm	480L40	V480LA40A
V480LTX80B	20mm	480TX80	V480LA80B
V510LTX40A	14mm	510L40	V510LA40A
V510LTX80B	20mm	510L80	V510LA80B

The TX Series of varistors are 100% screened and conditioned in accordance with MIL-STD-750. These tests are outlined in table 3 below

QA ACCEPTANCE **INSPECTION LOTS** REVIEW OF DATA LOTS PROPOSED SAMPLE PER 100% SCREENING FORMED AFTER TX PREPARATION > > > > FOR TX TYPES APPLICABLE DEVICE **ASSEMBLY** FOR DELIVERY **SPECIFICATION**

Table 3. TX Equivalents Series 100% Screening

	MIL-STD-105		LTPD	
	LEVEL	AQL	LIFD	
Electrical (Bidirectional) $V_{N(DC)}$, V_{C} (Per Specifications Table)	II	0.1	-	
Dielectric Withstand Voltage MIL–STD–202, Method 301, 2500V Min. at $1.0\mu A_{\rm DC}$	-	-	15	
Solderability MIL–STD–202, Method 208, No Aging, Non-Activated	-	-	15	

Metal-Oxide Varistors (MOVs) High Reliability Varistors

Table 4. Quality Assurance Acceptance Tests

Screen	MIL-STD-750 Method	Condition	TX Requirements
High Temperature Life (Stabilization Bake)	1032	24 hours min at max rated storage temperature.	100%
Thermal Shock			
(Temperature Cycling) No dwell is required at 25°C. Test condition A1, 5 cycles -55°C to (extremes) >10 minutes.		No dwell is required at 25°C. Test condition A1, 5 cycles -55°C to +125°C (extremes) >10 minutes.	100%
Humidity Life		85°C, 85% RH, 168 Hrs.	100%
Interim Electrical $V_{N(DC)} V_{C}$ (Note 3)		As specified, but including delta parameter as a minimum.	100% Screen
Power Burn-In	1038	Condition B, 85°C, rated V _{M(AC)} , 72 hours min.	100%
Final Electrical $+V_{N(DC)}V_{C}$ (Note 3)		As specified - All parameter measurements must be completed within 96 hours after removal from burn-in conditions.	100% Screen
External Visual Examination	2071	To be performed after complete marking.	100%

3) Custom Types

In addition to our comprehensive high-reliability series, Littelfuse can screen and condition to specific requirements. Additional mechanical and environmental capabilities are defined in Table 5.

Table 5. Mechanical And Environmental Capabilities (Typical Conditions)

Test Name	Test Method	Description	
Terminal Strength	MIL-STD-750-2036	3 Bends, 90° Arc, 16oz. Weight	
Drop Shock	MIL-STD-750-2016	1500g's, 0.5ms, 5 Pulses, X ₁ , V ₁ , Z ₁	
Variable Frequency Vibration	MIL-STD-750-2056	20g's, 100-2000Hz, X ₁ , V ₁ , Z ₁	
Constant Acceleration	MIL-STD-750-2006	V ₂ , 20,000g's Min	
Salt Atmosphere	MIL-STD-750-1041	35°C, 24Hr, 10-50g/m² Day	
Soldering Heat/Solderability	MIL-STD-750-2031/2026	260°C, 10s, 3 Cycles, Test Marking	
Resistance to Solvents	MIL-STD-202-215	Permanence, 3 Solvents	
Flammability	MIL-STD-202-111	15s Torching, 10s to Flameout	
Cyclical Moisture Resistance	MIL-STD-202-106	10 Days	
Steady-State Moisture Resistance	MIL-STD-750-1021.3	85/85 96Hr	
Biased Moisture Resistance	MIL-STD-750-1021.3	Not Recommended for High-Voltage Types	
Temperature Cycle	MIL-STD-202-107	-55°C to 125°C, 5 Cycles	
High-Temperature Life (Nonoperating)	MIL-STD-750-1032	125°C, 24Hr	
Burn-In	MIL-STD-750-1038	Rated Temperature and V _{RMS}	
Hermetic Seal	MIL-STD-750-1071	Condition D	



Radiation Hardness

For space applications, an extremely important property of a protection device is its response to imposed radiation effects.

Electron Irradiation

A Littelfuse MOV and a Silicon transient suppression diode were exposed to electron irradiation. The V-I curves, before and after test, are shown below.

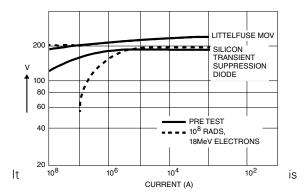


FIGURE 1. RADIATION SENSITIVITY OF LITTELFUSE V130LA1 AND SILICON TRANSIENT SUPPRESSION DIODE

apparent that the Littelfuse MOV was virtually unaffected, even at the extremely high dose of 108 rads, while the Silicon transient suppression diode showed a dramatic increase in leakage current.

Neutron Effects

A second MOV-Zener comparison was made in response to neutron fluence. The selected devices were equal in area.

Figure 2 shows the clamping voltage response of the MOV and the Zener to neutron irradiation to as high as 1015 N/cm². It is apparent that in contrast to the large change in the Zener, the MOV is unaltered. At highercurrents where the MOV's clamping voltage is again unchanged, the Zener device clamping voltage increases by as much as 36%.

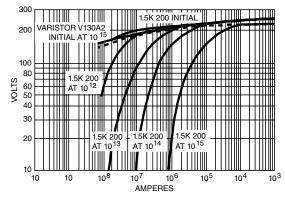


FIGURE 2. V-I CHARACTERISTIC RESPONSE TO NEUTRON IRRADIATION FOR MOV AND ZENER DIODE DEVICES

Counterclockwise rotation of the V-I characteristics is observed in Silicon devices at high neutron irradiation levels; in other words, increasing leakage at low current levels and increasing clamping voltage at higher current levels.

The solid and open circles for a given fluence represent the high and low breakdown currents for the sample of devices tested. Note that there is a marked decrease in current (or energy) handling capability with increased neutron fluence.

Failure threshold of Silicon semiconductor junctions is further reduced when high or rapidly increasing currents are applied. Junctions develop hot spots, which enlarge until a short occurs if current is not limited or quickly removed.

The characteristic voltage current relationship of a P– N Junction is shown below.

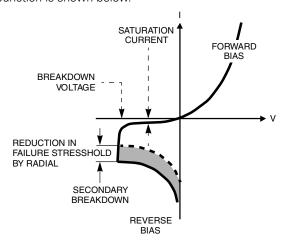


FIGURE 3. V-I CHARACTERISTIC OF PN-JUNCTION

At low reverse voltage, the device will conduct very little current (the saturation current). At higher reverse voltage VBO (breakdown voltage), the current increases rapidly as the electrons are either pulled by the electric field (Zener effect) or knocked out by other electrons (avalanching). A further increase in voltage causes the device to exhibit a negative resistance characteristic leading to secondary breakdown.

This manifests itself through the formation of hotspots, and irreversible damage occurs. This failure threshold decreases under neutron irradiation for Zeners, but not for Z_NO Varistors.

Gamma Radiation

Radiation damage studies were performed on type V130LA2 varistors. Emission spectra and V-I characteristics were collected before and after irradiation with 106 rads Co60 gamma radiation. Both show no change, within experimental error, after irradiation.